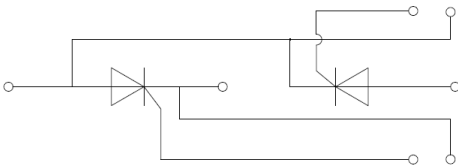




°C		



	°C			
				°C
				°C



	°C					
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	°C					
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FIG 1: Power dissipation vs. on-state current

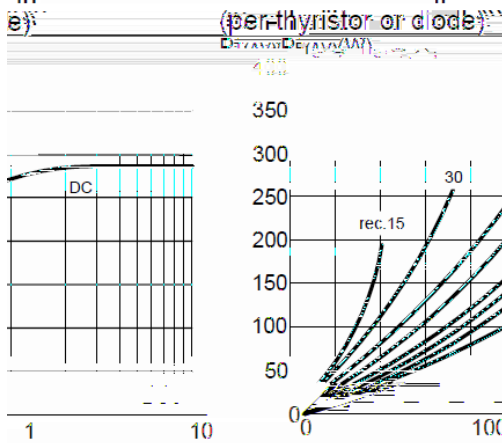


FIG 2: Maximum transient thermal impedance

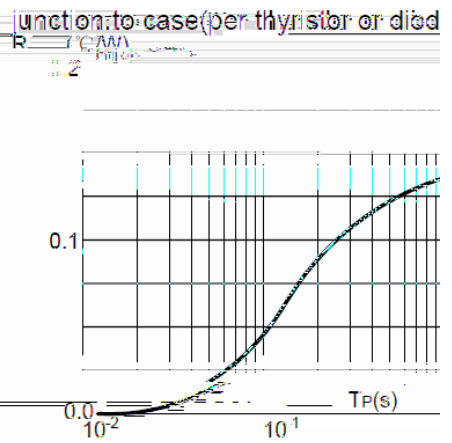


FIG 3: Forward characteristics

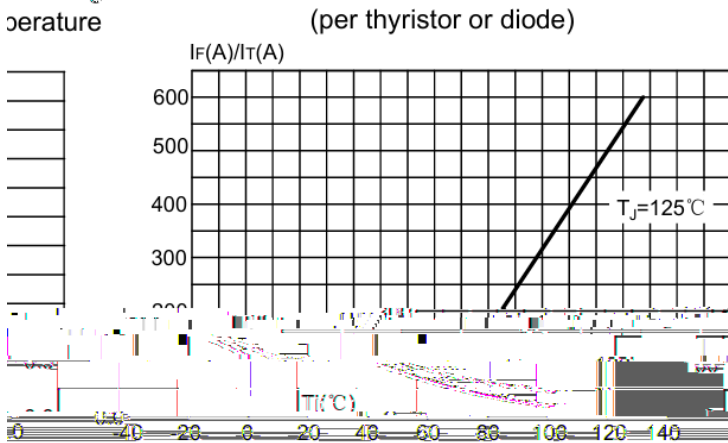


FIG 4: Relative variation of gate trigger current and latching current versus junction temperature

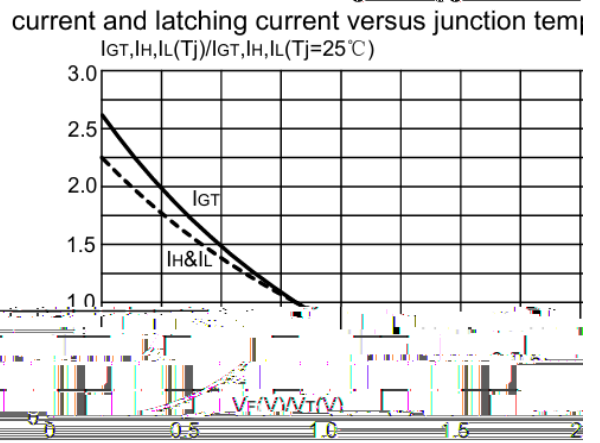


FIG 5: Gate trigger characteristics

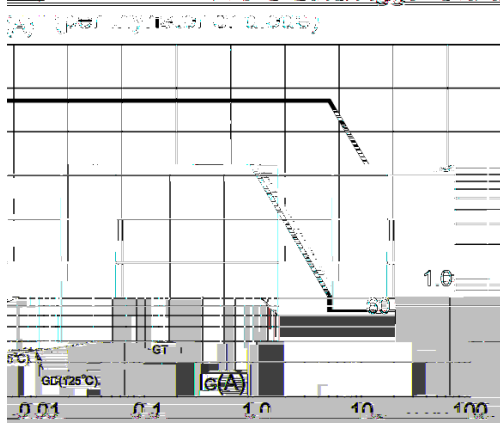


FIG 6: Forward current vs. case temperature

